

NCE Automotive P-Channel Super Trench Power MOSFET

Description

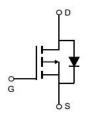
The NCEAP40P80K uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =-40V, I_D =-95A $R_{DS(ON)}$ =7.2m Ω (typical) @ V_{GS} =-10V $R_{DS(ON)}$ =11m Ω (typical) @ V_{GS} =-4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested
- 100% ∆Vds tested
- AEC-Q101 qualified

Application

- Automotive application
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic Diagram



Marking and pin assignment



TO-252 -2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AP40P80K	NCEAP40P80K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-40	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	Ι _D	-95	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-67	Α
Pulsed Drain Current	I _{DM}	-360	Α
Maximum Power Dissipation	P _D	150	W
Derating factor		1	W/°C
Single pulse avalanche energy (Note 1)	E _{AS}	500	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case	R _{θJC}	1.0	°C/W
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NCEAP40P80K

Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						•
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0V I_D =-250 μ A	-40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V -		-	±100	nA
On Characteristics (Note 3)						,
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-0.8	-1.4	-2.2	V
Dunin Course On State Besistance	Б	V _{GS} =-10V, I _D =-20A	-	7.2	8.8	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-20A	-	11	14	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	-	30	-	S
Dynamic Characteristics	·					,
Input Capacitance	Clss	.,	-	3700	-	pF
Output Capacitance	Coss	V _{DS} =-20V,V _{GS} =0V,	-	880	-	pF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	20	-	pF
Switching Characteristics (Note 2)						•
Turn-on Delay Time	t _{d(on)}		-	10.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =-20 V , I_{D} =-20 A	-	4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{G} =1.6 Ω	-	35	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg	V 00V/1 00A	-	57	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-20V, I_{D} =-20A,	-	9.8	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =-20A	-		-1.2	V
Diode Forward Current	Is		-	-	-95	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =-20A	-	-	24	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	-	68	nC

Notes:

^{1.} EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=-20V,VG=-10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.



Typical Electrical and Thermal Characteristics

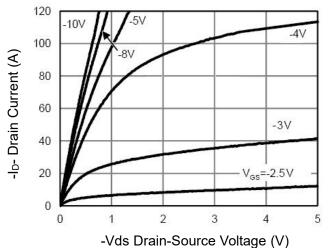


Figure 1 Output Characteristics

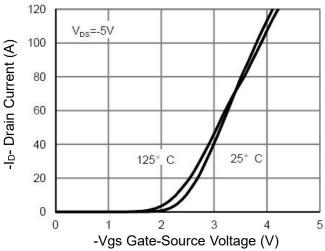


Figure 2 Transfer Characteristics

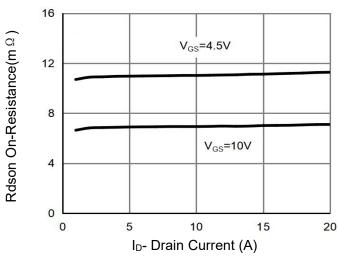


Figure 3 Rdson-Drain Current

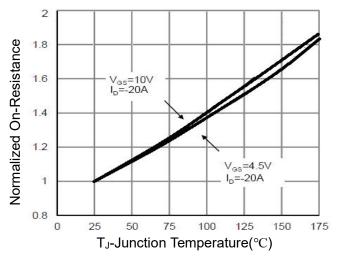


Figure 4 Rdson-JunctionTemperature

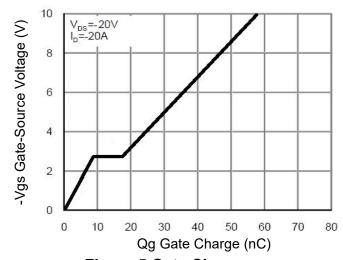


Figure 5 Gate Charge

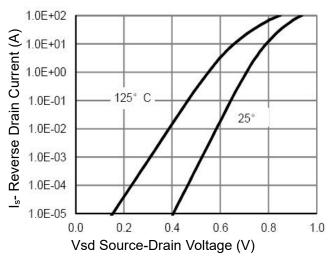


Figure 6 Source- Drain Diode Forward



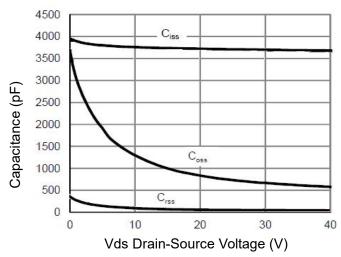


Figure 7 Capacitance vs Vds

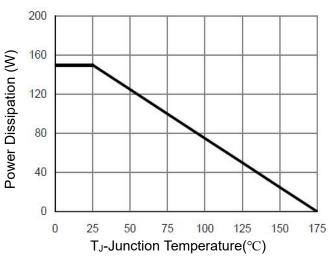


Figure 9 Power De-rating

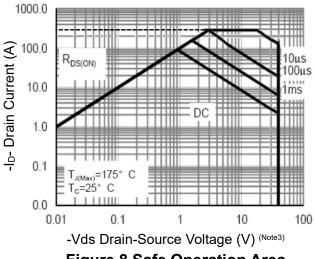


Figure 8 Safe Operation Area

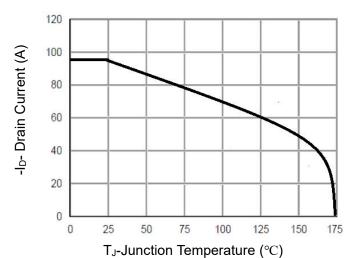


Figure 10 Current De-rating

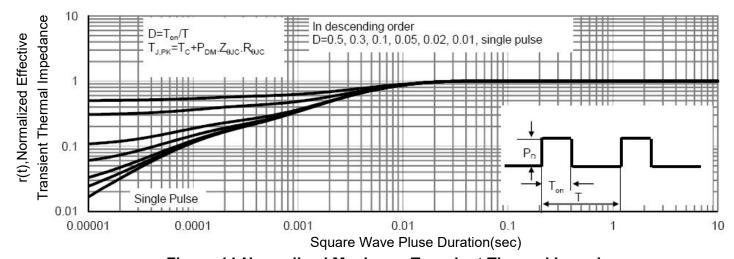
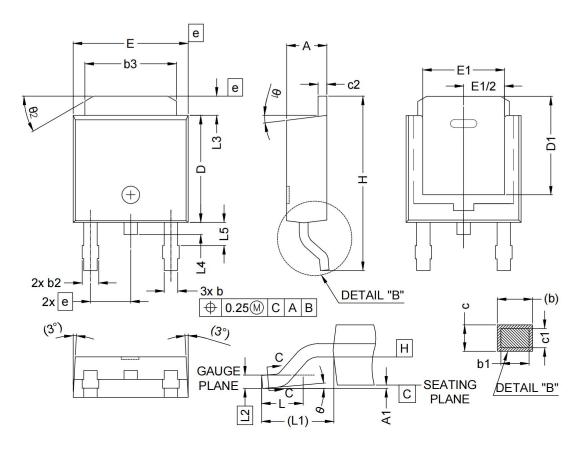


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252-2L Package Information



SYMBOL	MIN.	MAX.	SYMBOL	MIN.	MAX.	SYMBOL	MIN.	MAX.
A	2.18	2.39	E	6.35	6.73	θ1	0°	15°
A1	-	0.13	E1	4.32	1,-	θ2	25°	35°
b	0.65	0.89	е	2.29	BSC		72	
b1	0.64	0.79	Н	9.94	10.34			
b2	0.76	1.13	L	1.50	1.78			
b3	4.95	5.46	L1	2.74]	REF			
c	0.46	0.61	L2	0.51	BSC			
c1	0.41	0.56	L3	0.89	1.27			
c2	0.46	0.60	L4	-	1.02			
D	5.97	6.22	L5	1.14	1.49			
D1	5.21	-	θ	0°	10°			

NOTE; 1.0 DIMENSIONING & TOLERANCEING CONFIRM TO ASME Y14.5M-1994.

2.0 ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES. 3.0 HEAT SINK SIDE FLASH IS MAX. 0.8mm.

4.0 RADIUS ON TERMINAL IS OPTIONAL.

http://www.ncepower.com

NCEAP40P80K

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